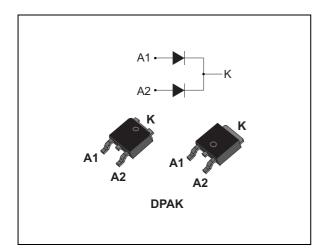


STPS15H100C

Datasheet - production data

High voltage power Schottky rectifier



Description

Dual center tab Schottky rectifier suited for switched mode power supply and high frequency DC to DC converters.

Packaged in DPAK, this device is intended for use in high frequency inverters.

Table 1. Device summary

Symbol	Value
I _{F(AV)}	2 x 7.5 A
V _{RRM}	100 V
Тj	175 °C
V _F (typ)	0.62 V

Features

- Negligible switching losses
- Low leakage current
- Good trade off between leakage current and forward voltage drop
- Low thermal resistance
- Avalanche capability specified
- ECOPACK[®]2 compliant component for DPAK on demand

1 Characteristics

Table 2. Absolute ratings (limiting values per diode at 25 °C unless otherwise specified)

Symbol	Paramete	Value	Unit			
V _{RRM}	Repetitive peak reverse voltage	Repetitive peak reverse voltage			V	
I _{F(RMS)}	Forward rms current			10	А	
1	Average forward current, δ = 0.5, square	$T_{c} = 135 \ ^{\circ}C^{(1)}$	Per diode	7.5	А	
I _{F(AV)} wave		$T_{c} = 135 \ C^{(1)}$	Per device	15	A	
I _{FSM}	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$			75	А	
P _{ARM}	Repetitive peak avalanche power $t_p = 10 \ \mu s, T_j = 125 \ ^{\circ}C$			475	W	
T _{stg}	Storage temperature range			-65 to +175	°C	
Т _ј	Maximum operating junction temperature ⁽²⁾	175	°C			

1. Value based on $R_{th(j-c)}$ max (per diode)

2. $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3	Thermal	resistance
I able J	. Inemiai	resistance

Symbol	Parameter			Unit
P	Junction to case	Per diode	4	
R _{th(j-c)}		Total	2.4	°C/W
R _{th(c)}	Coupling		0.7	

When the diodes 1 and 2 are used simultaneously:

 ΔT_j (diode 1) = P(diode1) x R_{th(j-c)}(Per diode) + P(diode 2) x R_{th(c)}

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
L (1)	Poverse leakage current	T _j = 25 °C	V _R = V _{RRM}			3	μA
'R` ′	I _R ⁽¹⁾ Reverse leakage current	T _j = 125 °C	$\nabla R = \nabla RRM$		1.3	4	mA
V _F ⁽²⁾ Forward voltage c		T _j = 25 °C	I _F = 7.5 A			0.8	
	Forward voltage drop	T _j = 125 °C	I _F = 7.5 A		0.62	0.67	
		T _j = 25 °C	I _F = 12 A			0.85	V
		T _j = 125 °C	I _F = 12 A		0.68	0.73	v
		T _j = 25 °C	Γ _j = 25 °C I _F = 15 A			0.89	
		T _j = 125 °C	I _F = 15 A		0.71	0.76	

Table 4. Static electrical characteristics (per diode)

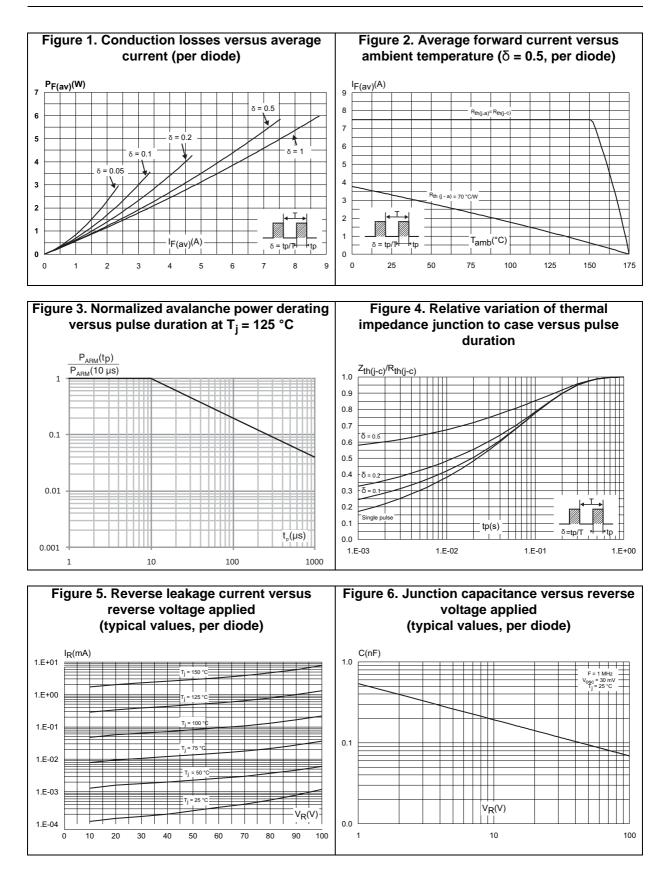
1. $t_p = 5 \text{ ms}, \delta < 2\%$

2. $t_p = 380 \ \mu s, \ \delta < 2\%$

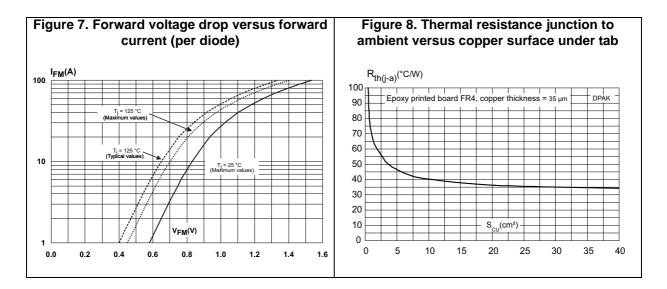
To evaluate the conduction losses use the following equation:

 $P = 0.58 \text{ x } I_{F(AV)} + 0.012 I_{F}^{2}(RMS)$











2 Package Information

- Epoxy meets UL94,V0
- Cooling method: by conduction (C)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

2.1 DPAK package information

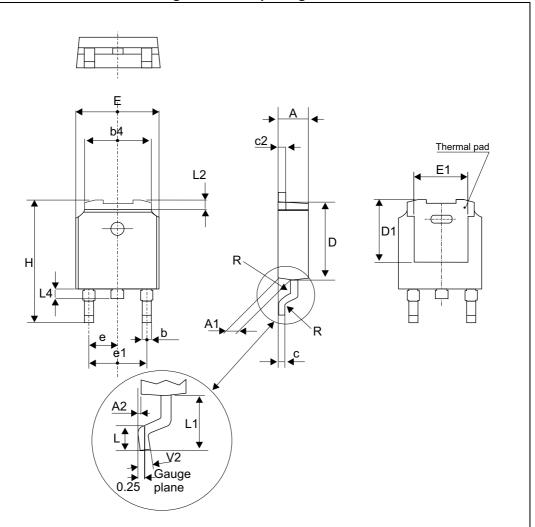


Figure 9. DPAK package outline

Note:

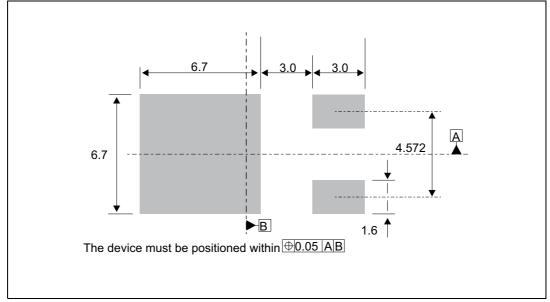
This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.



	Dimensions						
Ref.		Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	2.18		2.40	0.085		0.094	
A1	0.90		1.10	0.035		0.043	
A2	0.03		0.23	0.001		0.009	
b	0.64		0.90	0.025		0.035	
b4	4.95		5.46	0.194		0.214	
С	0.46		0.61	0.018		0.024	
c2	0.46		0.60	0.018		0.023	
D	5.97		6.22	0.235		0.244	
D1	4.95		5.60	0.194		0.220	
E	6.35		6.73	0.250		0.264	
E1	4.32		5.50	0.170		0.216	
е		2.28			0.090		
e1	4.40		4.70	0.173		0.185	
Н	9.35		10.40	0.368		0.409	
L	1.00		1.78	0.039		0.070	
L2	1		1.27			0.050	
L4	0.60		1.02	0.023		0.040	
V2	-8°		+8°	-8°		8°	

Table 5. DPAK package mechanical data







3 Ordering Information

Table	6.	Orderina	information
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Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS15H100CB	S15H100	DPAK	0.30 g	75	Tube
STPS15H100CB-TR	S15H100	DPAK	0.30 g	2500	Tape and reel

4 Revision history

Date	Revision Description of Changes			
Mar-2004	3	Last issue		
08-Jun-2006	4	Reformatted to current standard. Added IPAK.		
01-Aug-2014	5	Updated DPAK package information and reformatted to current standard. Removed IPAK.		
17-Sep-2014	6	Updated Figure 3 and Figure 11.		
18-Dec-2015	7	Updated DPAK package information and reformatted to current standard.		

Table 7. Document revision history



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